

SpinPac ASC 200/300

Wafer Level Frontside, Backside and Edge Coating

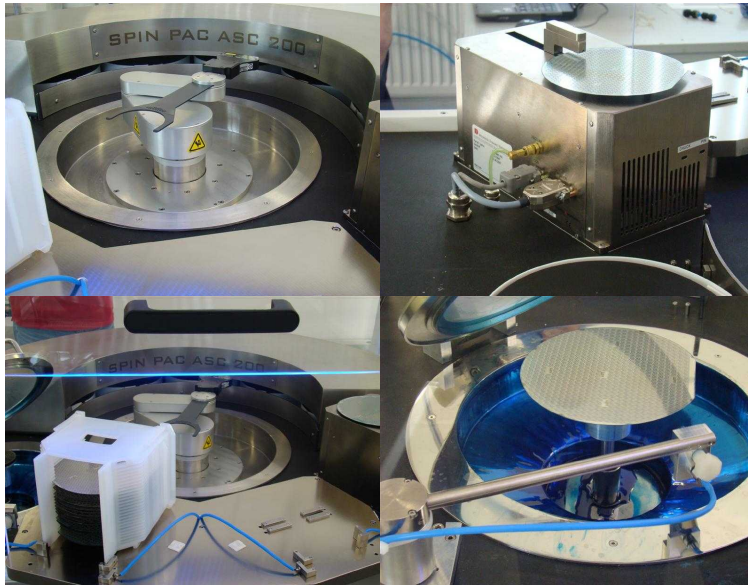
Resist or Flux Coating for Wafers up to 12"

Specifications:

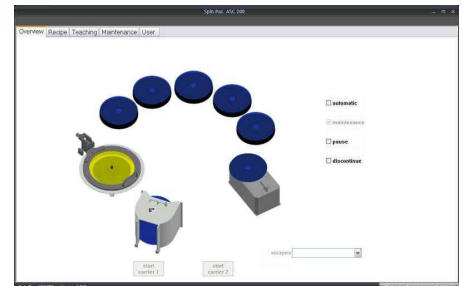
- Wafer thickness 0,1 to 1 mm
- Full automatic handling system
- Wafer sizes: 6 – 8 or 12 inch
- No tooling cost
- Volume production & prototyping capability
- Stainless Steel Body
- Free programmable time for pre heating and final heating
- Temperature free adjustable from 0 – 200` C
- Prealigner for Wafer handling
- Edge Coating
- Automatically handling for Wafer up to 50 /hour
- Semi conform HMI
- Exhaust can be connect to exhaust system
- Small Footprint
- Process logging



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Semi conform HMI

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